

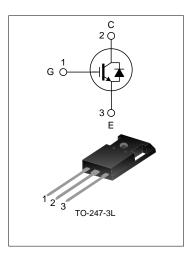
## **50A, 650V FIELD STOP IGBT**

#### **DESCRIPTION**

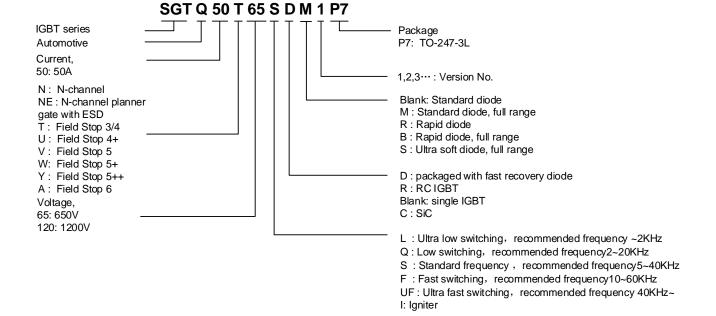
The SGTQ50T65SDM1P7 field stop IGBT adopts Silan Field Stop III technology. It features low conduction loss and switching loss, is applicable to photovoltaic, UPS, SMPS and PFC fields.

#### **FEATURES**

- AEC-Q101 qualified
- 50A, 650V, V<sub>CE(sat)(typ.)</sub>=1.65V@I<sub>C</sub>=50A
- Low conduction loss
- Fast switching
- High input impedance
- T<sub>Jmax</sub>=175°C



#### **NOMENCLATURE**



#### **ORDERING INFORMATION**

Part No.	Part No. Package Marking		Hazardous Substance Control	Packing Type	
SGTQ50T65SDM1P7	TO-247-3L	Q50T65SDM1	Halogen free	Tube	

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## ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, T<sub>C</sub>=25°C)

Charac	teristics	Symbol	Ratings	Unit
Collector to Emitter Voltage		$V_{CE}$	650	V
Gate to Emitter Vo	ltage	$V_{GE}$	±20	V
Transient Gate-Emitter Voltage (t <sub>p</sub> ≤10µs, D<0.010)		$V_{GE}$	±30	V
Collector Current	T <sub>C</sub> =25°C	1	100	Α
Collector Current	T <sub>C</sub> =100°C	- I <sub>C</sub>	50	А
Pulsed Collector C	Pulsed Collector Current		150	Α
Diode current	T <sub>C</sub> =25°C	· I <sub>F</sub>	100	Α
	T <sub>C</sub> =100°C		50	A
Diode Pulse Current		I <sub>FM</sub>	150	Α
Power Dissipation (T <sub>C</sub> =25°C)		P <sub>tot</sub>	500	W
Operating Junction Temperature		TJ	-40∼+175	°C
Storage Temperatu	ıre Range	T <sub>stg</sub>	-55∼+150	°C

## THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Thermal Resistance, Junction to Case	R <sub>th(j-C)</sub>				0.30	°C/W
(IGBT)	T (III(J-C)				0.00	0,77
Thermal Resistance, Junction to Case	2				0.05	0000
(FRD)	$R_{th(j-C)}$				0.65	°C/W
Thermal Resistance, Junction to	-				40	0000
Ambient (IGBT)	$R_{th(j-a)}$				40	°C/W
Soldering Temperature (in line)	T <sub>sold</sub>	15 <sup>+2</sup> <sub>-0</sub> sec, 1time			260	°C

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## ELECTRICAL CHARACTERISTICS OF IGBT (UNLESS OTHERWISE NOTED, T<sub>C</sub>=25°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Collector to Emitter Breakdown Voltage	V <sub>(BR)CES</sub>	V <sub>GE</sub> =0V, I <sub>C</sub> =250μA	650			V
C-E Leakage Current	I <sub>CES</sub>	V <sub>CE</sub> =650V, V <sub>GE</sub> =0V			200	μA
G-E Leakage Current	I <sub>GES</sub>	V <sub>GE</sub> =20V, V <sub>CE</sub> =0V			±400	nA
G-E Threshold Voltage	$V_{GE(th)}$	I <sub>C</sub> =250uA, V <sub>CE</sub> =V <sub>GE</sub>	4.0	5.0	7.0	V
Collector to Emitter		I <sub>C</sub> =50A, V <sub>GE</sub> =15V, T <sub>C</sub> =25°C		1.65	2.2	V
Saturation Voltage	V <sub>CEsat</sub>	I <sub>C</sub> =50A, V <sub>GE</sub> =15V, T <sub>C</sub> =175°C		1.95		V
Input Capacitance	Cies	V 20V		2723		
Output Capacitance	C <sub>oes</sub>	V <sub>CE</sub> =30V		230		F
Reverse Transfer Capacitance	C <sub>res</sub>	V <sub>GE</sub> =0V f=1MHz		55		pF
Turn-On Delay Time	T <sub>d(on)</sub>			46		
Rise Time	Tr	$V_{CE}=400V$ $I_{C}=50A$ $R_{g}=10\Omega$ $V_{GE}=15V$ inductive load $T_{C}=25^{\circ}C$		36		ns
Turn-Off Delay Time	T <sub>d(off)</sub>			173		
Fall Time	T <sub>f</sub>			78		
Turn-On Switching Loss	Eon			0.65		
Turn-Off Switching Loss	E <sub>off</sub>			1.22		mJ
Total Switching Loss	E <sub>st</sub>			1.87		1
Turn-On Delay Time	T <sub>d(on)</sub>			40		
Rise Time	Tr	V <sub>CE</sub> =400V		23		
Turn-Off Delay Time	T <sub>d(off)</sub>	I <sub>C</sub> =25A		188		ns
Fall Time	T <sub>f</sub>	$R_g=10\Omega$		81		
Turn-On Switching Loss	E <sub>on</sub>	V <sub>GE</sub> =15V		0.22		
Turn-Off Switching Loss	E <sub>off</sub>	inductive load T <sub>C</sub> =25°C		0.65		mJ
Total Switching Loss	E <sub>st</sub>			0.87		
Total Gate Charge	$Q_g$			123		
Gate to Emitter Charge	$Q_ge$	V <sub>CE</sub> =400V, I <sub>C</sub> =50A, V <sub>GE</sub> =15V		31		nC
Gate to Collector Charge	$Q_{gc}$			48		

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## ELECTRICAL CHARACTERISTICS OF FRD (T<sub>C</sub>=25°C, UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Diode Forward Voltage	\/	I <sub>F</sub> =50A, T <sub>C</sub> =25°C		1.70	2.50	V
	V <sub>F</sub>	I <sub>F</sub> =50A, T <sub>C</sub> =175°C		1.25		
Diode Reverse Recovery	т	I <sub>ES</sub> =50A, dI <sub>ES</sub> /dt=200A/μs		38		ns
Time	T <sub>rr</sub>					
Diode Reverse Recovery	Q <sub>rr</sub>			78		nC
Charge				70		nc
Diode Reverse Recovery	I <sub>rrm</sub>			5.8		۸
Current				5.6		Α

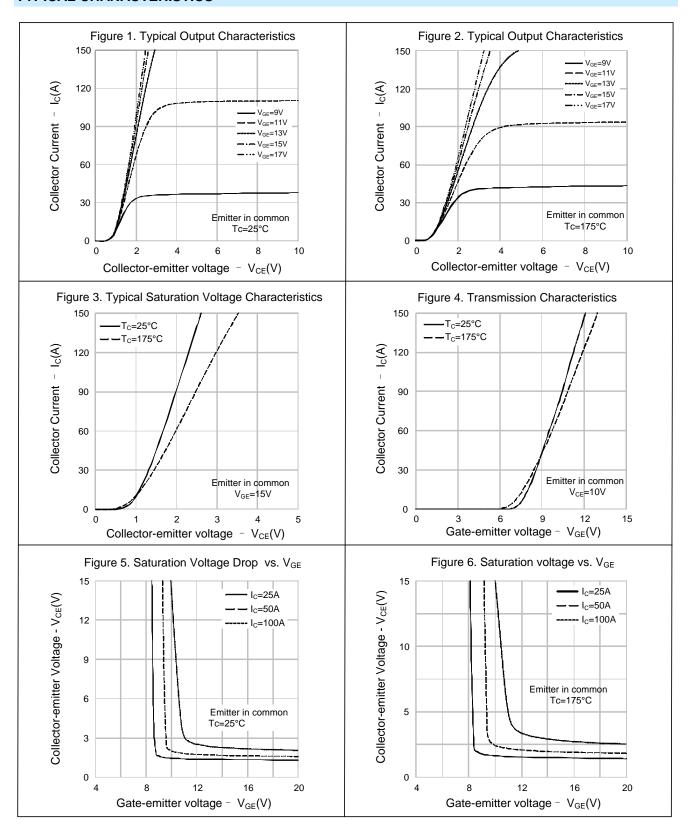
## **ELECTRICAL CHARACTERISTICS OF IGBT (T<sub>C</sub>=175°C)**

Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Turn-On Delay Time	T <sub>d(on)</sub>	1001		44		ns
Rise Time	Tr	V <sub>CE</sub> =400V		35		
Turn-Off Delay Time	T <sub>d(off)</sub>	I <sub>C</sub> =50A		202		
Fall Time	T <sub>f</sub>	$R_g=10\Omega$		140		
Turn-On Switching Loss	Eon	V <sub>GE</sub> =15V		0.72		
Turn-Off Switching Loss	E <sub>off</sub>	inductive load – T <sub>C</sub> =175°C –		1.88		mJ
Total Switching Loss	E <sub>st</sub>			2.60		
Turn-On Delay Time	T <sub>d(on)</sub>	1001		38		
Rise Time	Tr	V <sub>CE</sub> =400V		23		20
Turn-Off Delay Time	T <sub>d(off)</sub>	$I_{C=25A}$ - $R_{g=10\Omega}$ - $V_{GE=15V}$ - inductive load		246		ns
Fall Time	T <sub>f</sub>			158		
Turn-On Switching Loss	E <sub>on</sub>			0.28		
Turn-Off Switching Loss	E <sub>off</sub>	T <sub>C</sub> =175°C		1.14		mJ
Total Switching Loss	E <sub>st</sub>	10-173 0		1.42		

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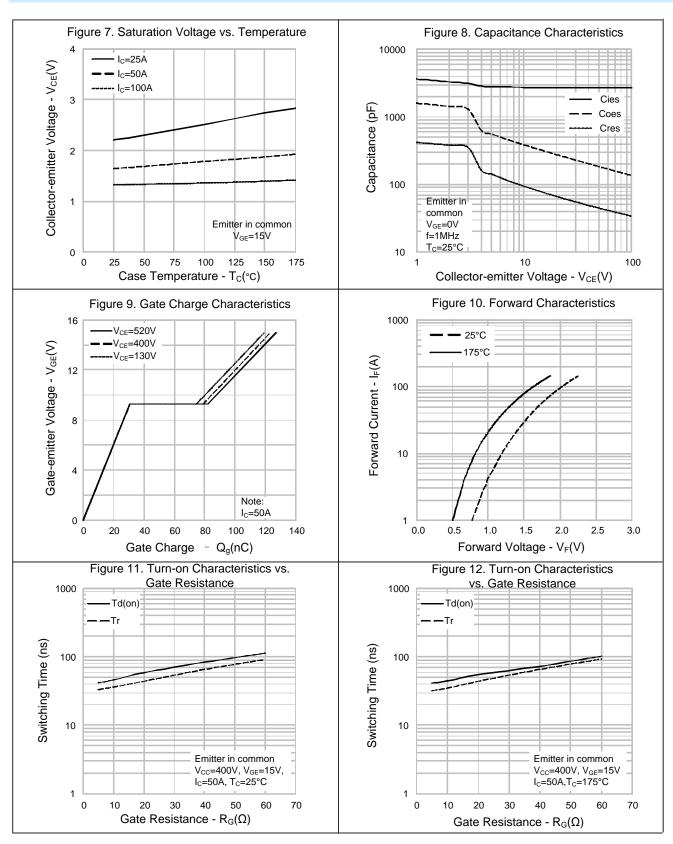


#### TYPICAL CHARACTERISTICS



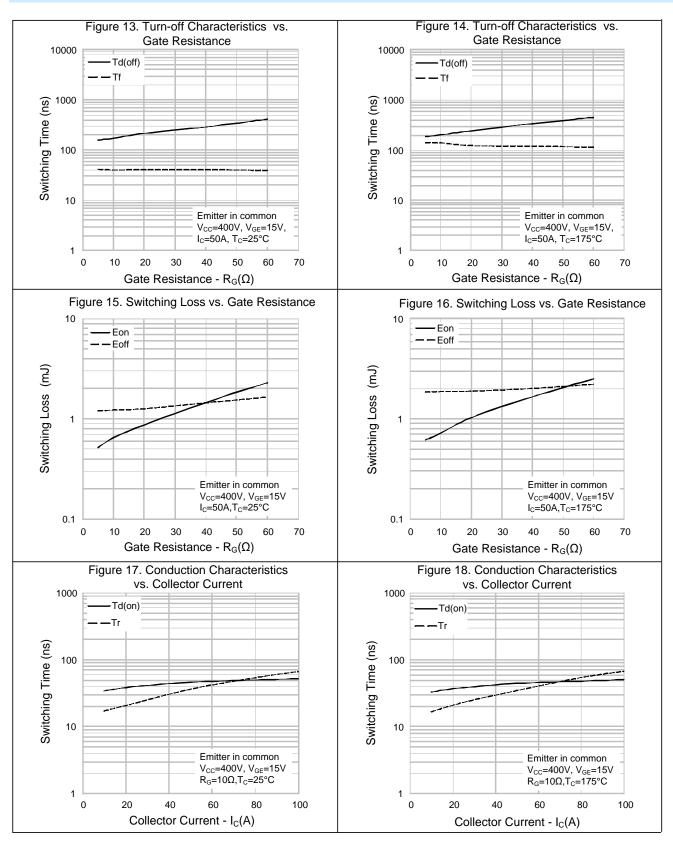
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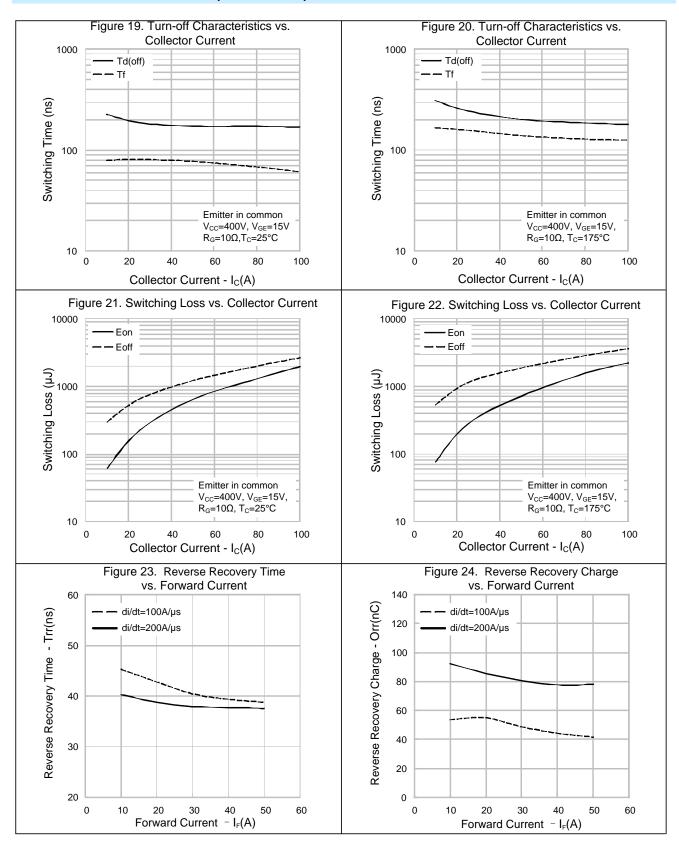
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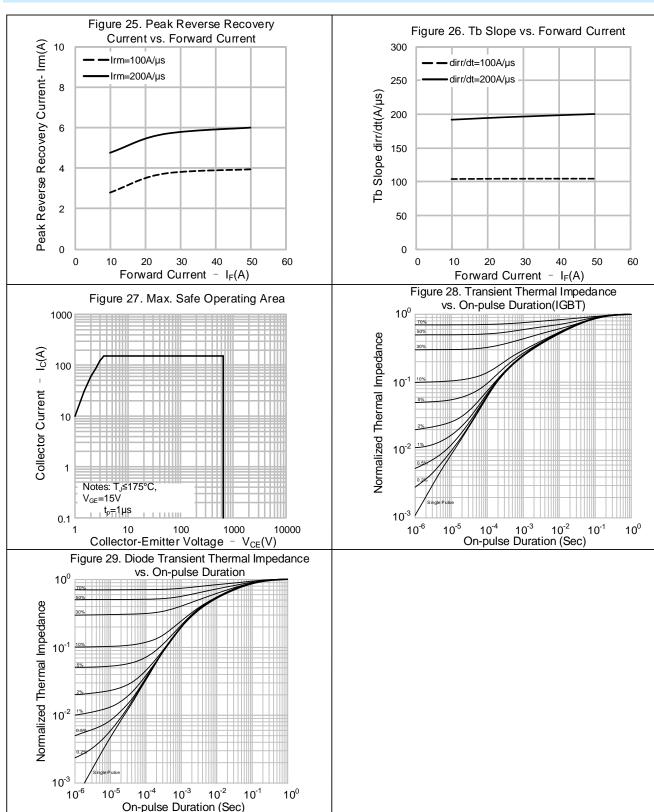
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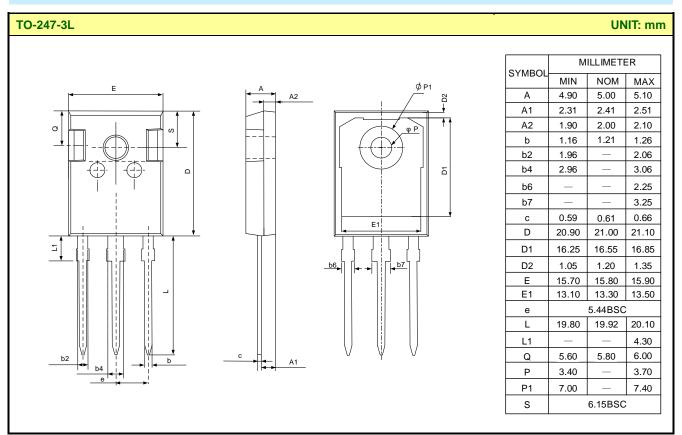




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#### **PACKAGE OUTLINE**





#### **IGBT DEVICES OPERATE NOTES:**

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the IGBT electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- IGBT devices should be packed in antistatic/conductive containers for transportation.

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#### Important notice:

- 1. Silan reserves the right to make changes of this instruction without notice.
- 2. Customers should obtain the latest relevant information when purchasing and should verify whether such information is latest and complete. Please read this instruction and application manual and related materials carefully before using products, including the circuit operation precautions, etc.
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- Product promotion is endless, our company will wholeheartedly provide customers with better products! 8.
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Revision History:

Update features

2. Update nomenclature

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Revision History:

First release

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